# FAIRCHILD

SEMICONDUCTOR®

October 2004

# ISL9V2040D3S / ISL9V2040S3S / ISL9V2040P3

EcoSPARK<sup>TM</sup> 200mJ, 400V, N-Channel Ignition IGBT

#### **General Description**

Formerly Developmental Type 49444

The ISL9V2040D3S, ISL9V2040S3S, and ISL9V2040P3 are the next generation ignition IGBTs that offer outstanding SCIS capability in the space saving D-Pak (TO-252), as well as the industry standard D<sup>2</sup>-Pak (TO-263) and TO-220 plastic packages. This device is intended for use in automotive ignition circuits, specifically as a coil driver. Internal diodes provide voltage clamping without the need for external components.

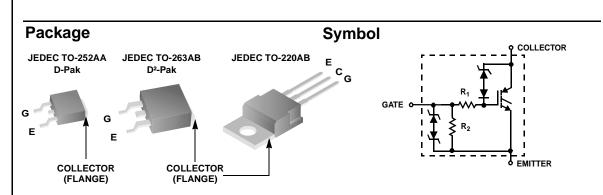
**EcoSPARK™** devices can be custom made to specific clamp voltages. Contact your nearest Fairchild sales office for more information.

# Applications

Automotive Ignition Coil Driver CircuitsCoil- On Plug Applications

#### Features

- Space saving D Pak package available
- SCIS Energy = 200mJ at T<sub>1</sub> = 25°C
- Logic Level Gate Drive

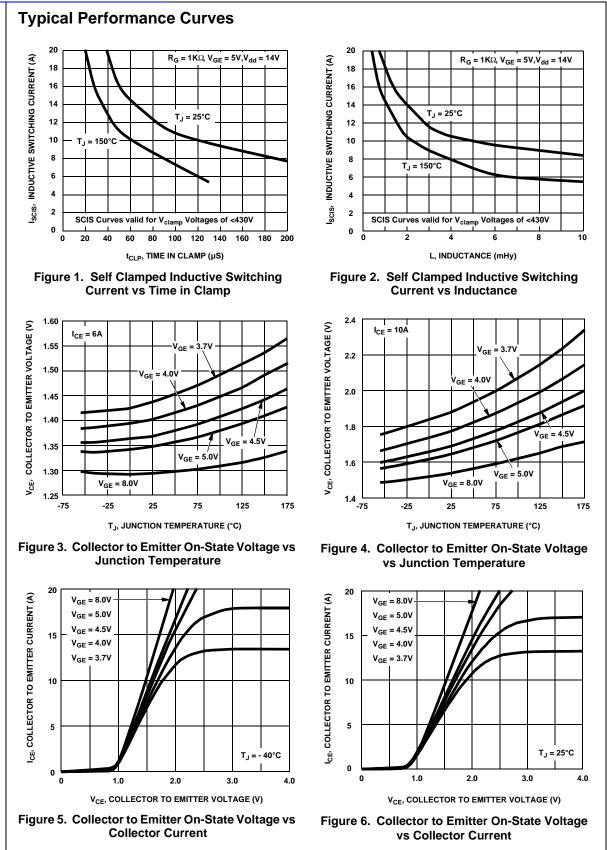


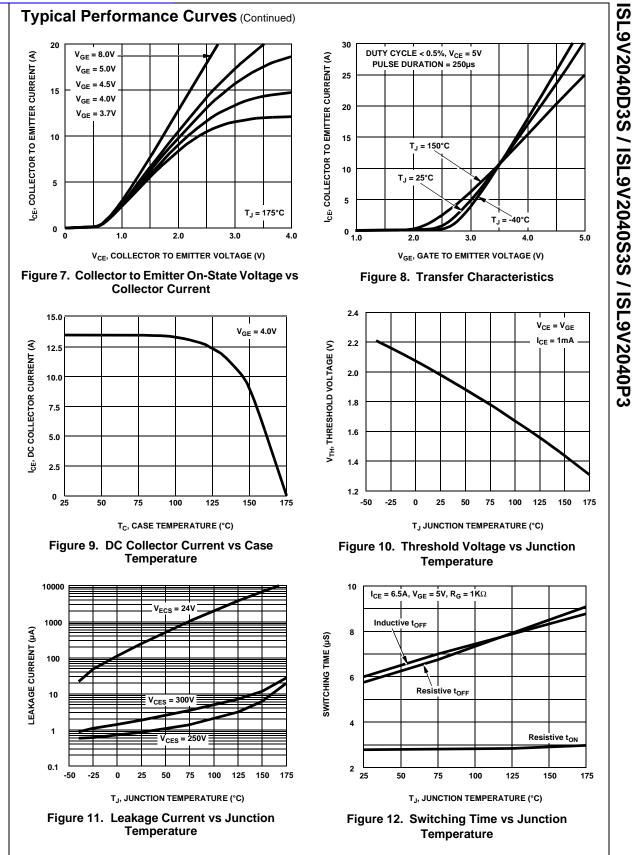
#### Device Maximum Ratings T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units V	
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage (I <sub>C</sub> = 1 mA)	430		
BV <sub>ECS</sub>	Emitter to Collector Voltage - Reverse Battery Condition (I <sub>C</sub> = 10 mA)	24	V	
E <sub>SCIS25</sub>	At Starting $T_J = 25^{\circ}$ C, $I_{SCIS} = 11.5$ A, L = 3.0mHy	200	mJ	
E <sub>SCIS150</sub>	At Starting $T_J = 150^{\circ}$ C, $I_{SCIS} = 8.9$ A, L = 3.0mHy	120	mJ	
I <sub>C25</sub>	Collector Current Continuous, At T <sub>C</sub> = 25°C, See Fig 9	10	Α	
I <sub>C110</sub>	Collector Current Continuous, At T <sub>C</sub> = 110°C, See Fig 9	10	А	
V <sub>GEM</sub>	Gate to Emitter Voltage Continuous	±10	V	
PD	$P_D$ Power Dissipation Total $T_C = 25^{\circ}C$		W	
	Power Dissipation Derating T <sub>C</sub> > 25°C		W/°C	
Τ <sub>J</sub>	T <sub>J</sub> Operating Junction Temperature Range		°C	
T <sub>STG</sub>	T <sub>STG</sub> Storage Junction Temperature Range		°C	
TL	T <sub>L</sub> Max Lead Temp for Soldering (Leads at 1.6mm from Case for 10s)		°C	
T <sub>pkg</sub> Max Lead Temp for Soldering (Package Body for 10s)		260	°C	
ESD			kV	

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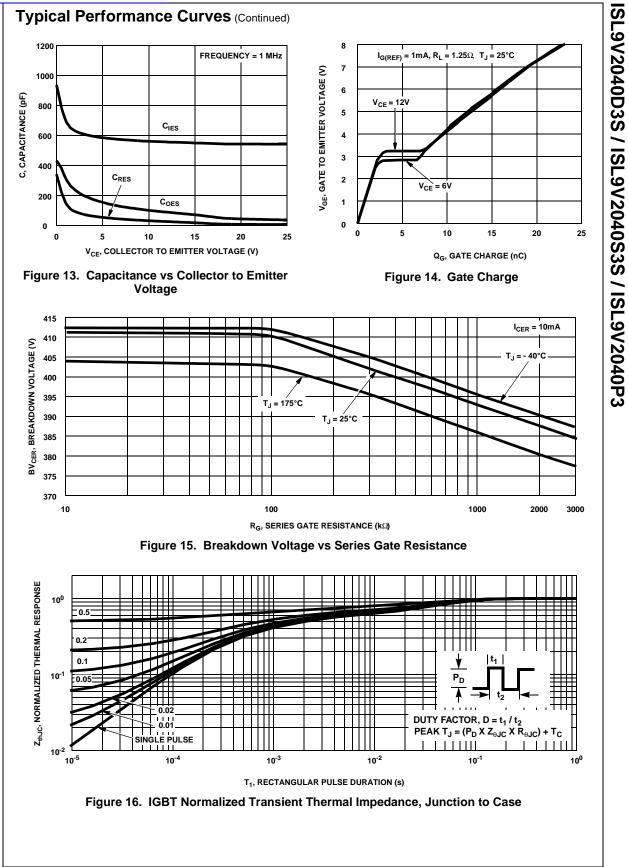
Device Marking		Device	P	ackage	Reel Size	Та	pe Width	Width Quantit		
V2040D		ISL9V2040D3ST	TC	)-252AA	-		16mm		2500	
V2040S		ISL9V2040S3ST	TC	0-263AB	330mm	24mm			800	
V2040P		ISL9V2040P3	TC	)-220AB	Tube	N/A			50	
V2040D		ISL9V2040D3S		)-252AA	Tube	N/A			75	
V204		ISL9V2040S3S		0-263AB	Tube		N/A		50	
Symbol	al Char	Parameter	25°C un	less otherwise n Test Con		Min	Тур	Max	Units	
f State	Charact	eristics		•						
BV <sub>CER</sub>	Collector	Collector to Emitter Breakdown Voltage		$I_{C} = 2mA, V_{GE} = 0,$ $R_{G} = 1K\Omega, See Fig. 15$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		370	400	430	V	
BV <sub>CES</sub>	Collector	to Emitter Breakdown \			= 0, ig. 15	390	420	450	V	
BV <sub>ECS</sub>	Emitter to	o Collector Breakdown \	/oltage	$I_C = -75$ mA, $V_{GE} = 0$ V, $T_C = 25$ °C		30	-	-	V	
$BV_{GES}$	_	Emitter Breakdown Volta	-	$I_{GES} = \pm 2mA$		±12	±14	-	V	
I <sub>CER</sub>	Collector	to Emitter Leakage Cur	rrent	V <sub>CER</sub> = 250V, R <sub>G</sub> = 1KΩ,	T <sub>C</sub> = 25°C T <sub>C</sub> = 150°C	-	-	25 1	μA mA	
				See Fig. 11	-	-	-	-	ША	
I <sub>ECS</sub>	Emitter to	o Collector Leakage Cur	rrent	V <sub>EC</sub> = 24V, See Fig. 11		-	-	1	mA	
D	Sorioo C	ata Rasistanaa		1 19. 1 1	T <sub>C</sub> = 150°C	-	-	40	mA	
R <sub>1</sub> R <sub>2</sub>	_	Series Gate Resistance Gate to Emitter Resistance				- 10K	70	- 26K	Ω Ω	
	Charact		- 14		T 05%0		4 45	4.0	V	
V <sub>CE(SAT)</sub>	Collector	to Emitter Saturation Vo	oltage	I <sub>C</sub> = 6A, V <sub>GE</sub> = 4V	T <sub>C</sub> = 25°C, See Fig. 3	-	1.45	1.9		
V <sub>CE(SAT)</sub>	Collector	Collector to Emitter Saturation Voltage		I <sub>C</sub> = 10A, V <sub>GE</sub> = 4.5V	T <sub>C</sub> = 150°C See Fig. 4	-	1.95	2.3	V	
/namic	Charact	eristics								
Q <sub>G(ON)</sub>	Gate Cha	<u> </u>		$I_C = 10A$ , $V_{CE} = 12V$ , $V_{GE} = 5V$ , See Fig. 14		-	12	-	nC	
V <sub>GE(TH)</sub>	Gate to E	Emitter Threshold Voltag	je	I <sub>C</sub> = 1.0mA, V <sub>CE</sub> = V <sub>GE,</sub> See Fig. 10	T <sub>C</sub> = 25°C T <sub>C</sub> = 150°C	1.3 0.75	-	2.2 1.8	V V	
V <sub>GEP</sub>	Gate to E	Emitter Plateau Voltage		$I_{\rm C} = 10$ A, $V_{\rm CE} =$	= 12V	-	3.4	-	V	
	1	teristics		0 02					1	
t <sub>d(ON)R</sub>	,	Turn-On Delay Time-Res	sistive	ive V <sub>CE</sub> = 14V, R <sub>L</sub> = 1Ω,		-	0.61	-	μs	
t <sub>riseR</sub>		Rise Time-Resistive		$V_{GE} = 5V, R_G = 1K\Omega$ $T_J = 25^{\circ}C$		-	2.17	-	μs	
t <sub>d(OFF)L</sub>		Turn-Off Delay Time-Ind	uctive	V <sub>CE</sub> = 300V, L = 500µHy,		-	3.64	-	μs	
	Current F	Fall Time-Inductive		$V_{GE} = 5V$ , $R_G = 1K\Omega$ $T_J = 25^{\circ}C$ , See Fig. 12		-	2.36	-	μs	
t <sub>fL</sub>	Self Clar	nped Inductive Switchin	g	$T_J = 25^{\circ}C, L = 3.0$ mHy, $R_G = 1K\Omega, V_{GE} = 5V$ , See Fig. 1 & 2		-	-	200	mJ	
t <sub>fL</sub> SCIS										
SCIS	Characte	eristics			-					



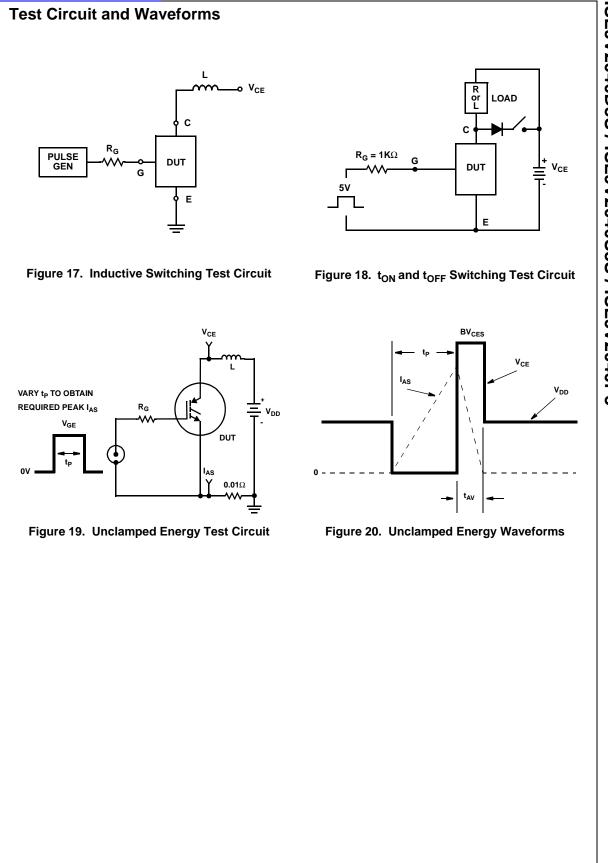


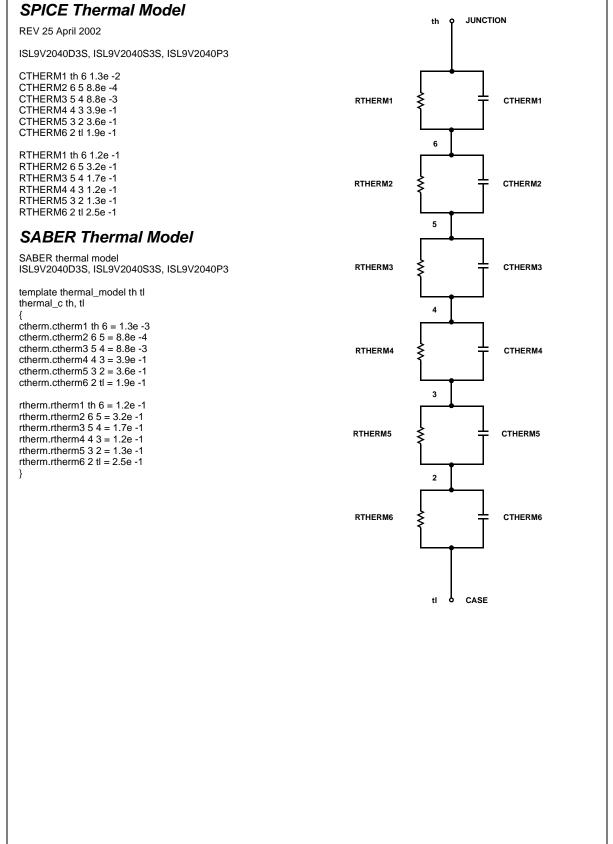
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